

阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网，版权归原作者所有。如读者和版权方有任何异议请及时告之，我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译，其目的是协助用户阅读，该译文无法自动跟随原稿更新，同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料，来自厂商的技术支持或者使用者的心得体会等，其内容可能存在描述上的差异，建议读者做出适当判断。
- 4.如需与我们联系，请发邮件到marketing@iczoom.com，主题请标有“数据手册”字样。

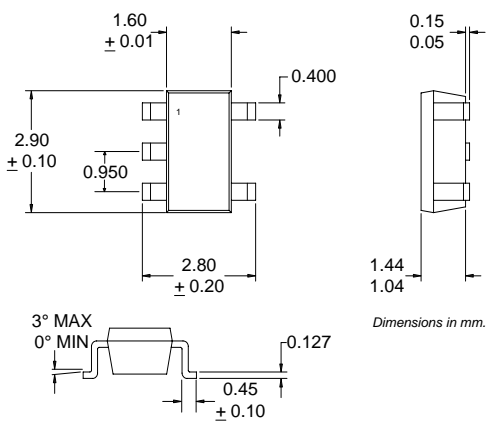
Read Statement

1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets" .

- Typical Applications**
- Broadband, Low Noise Gain Blocks
 - IF or RF Buffer Amplifiers
 - Driver Stage for Power Amplifiers
 - Final PA for Low Power Applications
 - Broadband Test Equipment

Product Description

The RF2334 is a general purpose, low-cost RF amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as an easily-cascadable 50Ω gain block. Applications include IF and RF amplification in wireless voice and data communication products operating in frequency bands up to 4000MHz. The device is self-contained with 50Ω input and output impedances and requires only two external DC biasing elements to operate as specified. The RF2334 is available in a very small industry-standard SOT23-5 surface mount package, enabling compact designs which conserve board space.

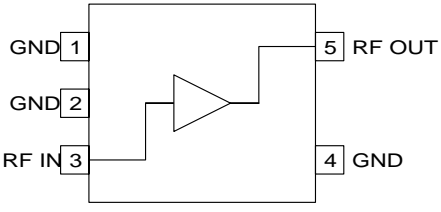


Optimum Technology Matching® Applied

- | | | |
|-------------------------------------|--|---------------------------------------|
| <input type="checkbox"/> Si BJT | <input checked="" type="checkbox"/> GaAs HBT | <input type="checkbox"/> GaAs MESFET |
| <input type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS |
| <input type="checkbox"/> InGaP/HBT | <input type="checkbox"/> GaN HEMT | <input type="checkbox"/> SiGe Bi-CMOS |

Package Style: SOT23-5

- Features**
- DC to 6000MHz Operation
 - Internally matched Input and Output
 - 16dB Small Signal Gain
 - 5dB Noise Figure
 - +18.5dBm Output Power
 - Single Positive Power Supply



Functional Block Diagram

Ordering Information

RF2334	General Purpose Amplifier
RF2334 PCBA	Fully Assembled Evaluation Board

RF Micro Devices, Inc.
7628 Thorndike Road
Greensboro, NC 27409, USA

Tel (336) 664 1233
Fax (336) 664 0454
<http://www.rfmd.com>

RF2334

Absolute Maximum Ratings

Parameter	Rating	Unit
Input RF Power	+13	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-60 to +150	°C



Caution! ESD sensitive device.

RF Micro Devices believes the furnished information is correct and accurate at the time of this printing. However, RF Micro Devices reserves the right to make changes to its products without notice. RF Micro Devices does not assume responsibility for the use of the described product(s).

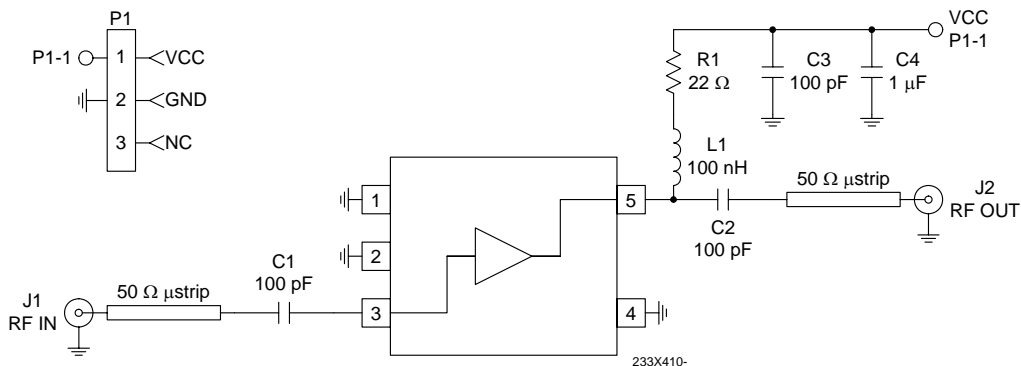
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Overall					T=25°C, I _{CC} =65mA
Frequency Range		DC to 6000		MHz	
3dB Bandwidth		2.5		GHz	
Gain		19.4		dB	Freq=100MHz
		18		dB	Freq=1000MHz
		16		dB	Freq=2000MHz
		14		dB	Freq=3000MHz
		13		dB	Freq=4000MHz
Gain Flatness		±2		dB	100MHz to 2000MHz
Noise Figure		4.8		dB	Freq=2000MHz
Input VSWR		2.1:1			In a 50Ω system, DC to 4000MHz
Output VSWR		1.8:1			In a 50Ω system, DC to 4000MHz
Output IP ₃		+33		dBm	Freq=1000MHz±50kHz, P _{TONE} =-10dBm
Output P _{1dB}		+18.5		dBm	Freq=1000MHz
Reverse Isolation		20.5		dB	Freq=2000MHz
Thermal					I _{CC} =65mA, P _{DISS} =300mW (See Note.)
Theta _{JC}		288		°C/W	
Maximum Measured Junction Temperature		172		°C	T _{AMB} =+85°C, V _{PIN} =4.64V
Mean Time Between Failures		400		years	See Note.
Power Supply					With 22Ω bias resistor
Device Operating Voltage		4.8		V	At pin 5 with I _{CC} =65mA
Supply Voltage		6.3		V	At evaluation board connector, I _{CC} =65mA
Operating Current		65	68	mA	See note.

Note: Because of process variations from part to part, the current resulting from a fixed bias voltage will vary. As a result, caution should be used in designing fixed voltage bias circuits to ensure the worst case bias current does not exceed 68mA over all intended operating conditions.

Pin	Function	Description	Interface Schematic
1	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
2	GND	Same as pin 1.	
3	RF IN	RF input pin. This pin is NOT internally DC-blocked. A DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
4	GND	Same as pin 1.	
5	RF OUT	RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V_{CC} . The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{SUPPLY} - V_{DEVICE})}{I_{CC}}$ Care should also be taken in the resistor selection to ensure that the current into the part never exceeds 68mA over the planned operating temperature . This means that a resistor between the supply and this pin is always required, even if a supply near 4.8V is available, to provide DC feedback to prevent thermal runaway. Because DC is present on this pin, a DC blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed.	

Evaluation Board Schematic

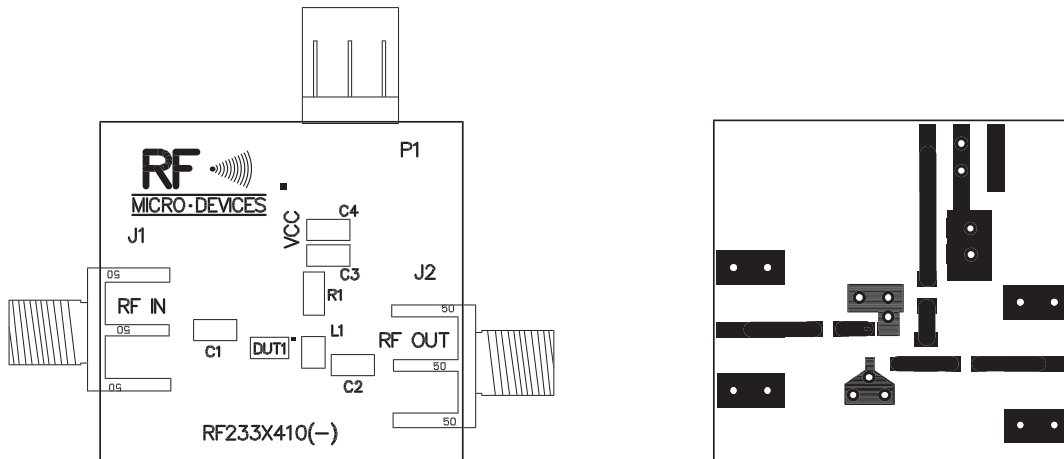
(Download [Bill of Materials](http://www.rfmd.com) from www.rfmd.com.)



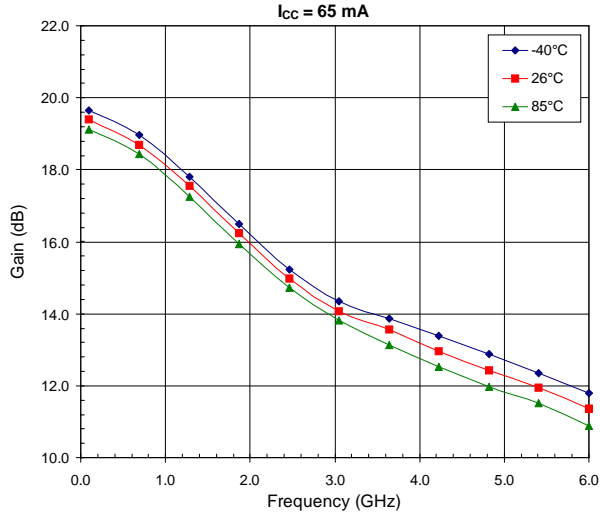
RF2334

Evaluation Board Layout Board Size 1.0" x 1.0"

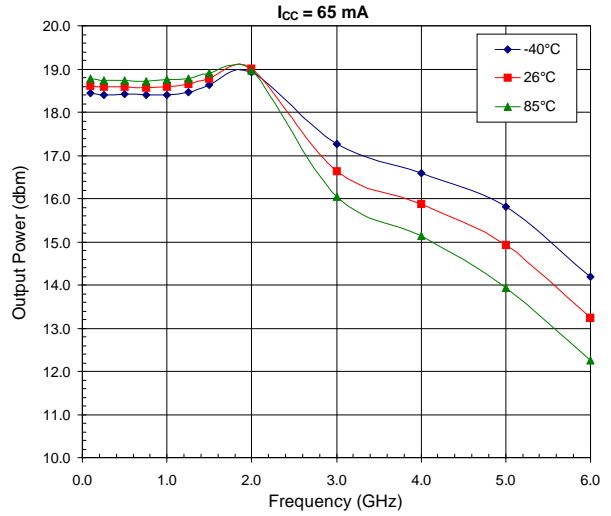
Board Thickness 0.020", Board Material R0-4003 Rogers



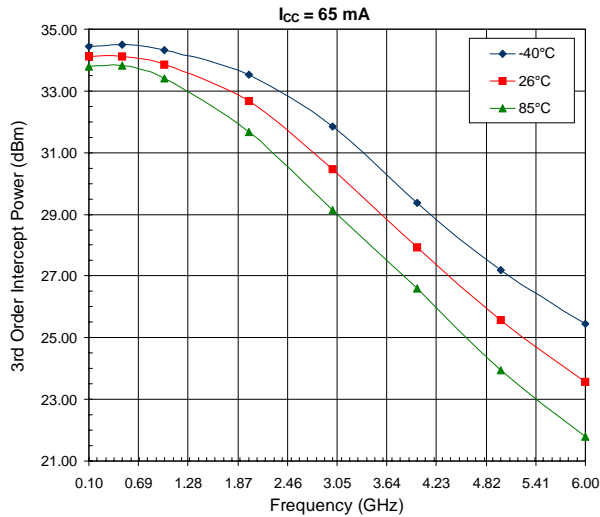
Gain versus Frequency Across Temperature



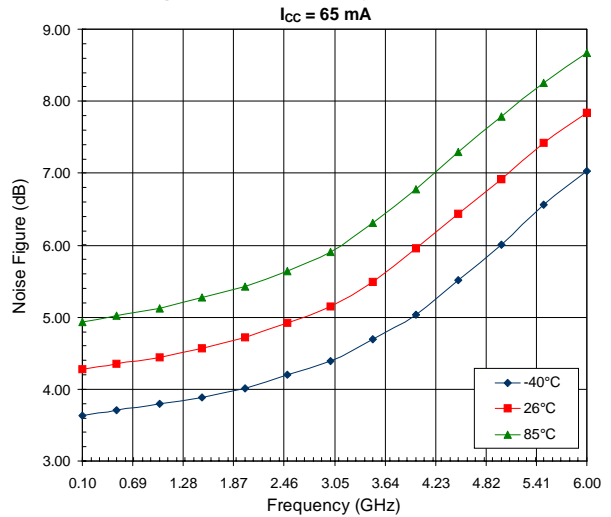
Output P1dB versus Frequency Across Temperature



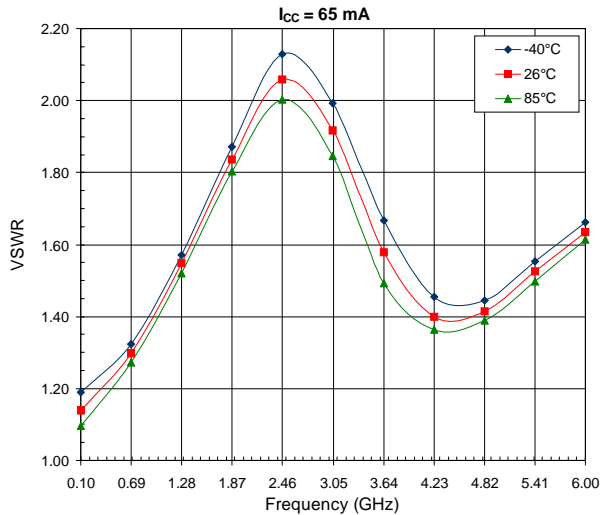
Output IP3 versus Frequency Across Temperature



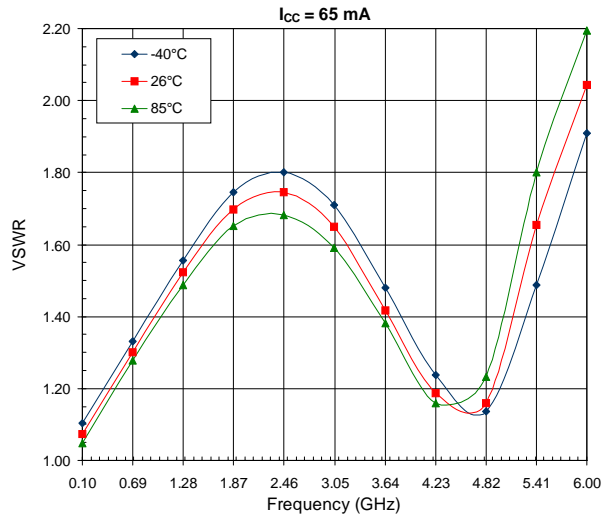
Noise Figure versus Frequency Across Temperature



Input VSWR versus Frequency Across Temperature

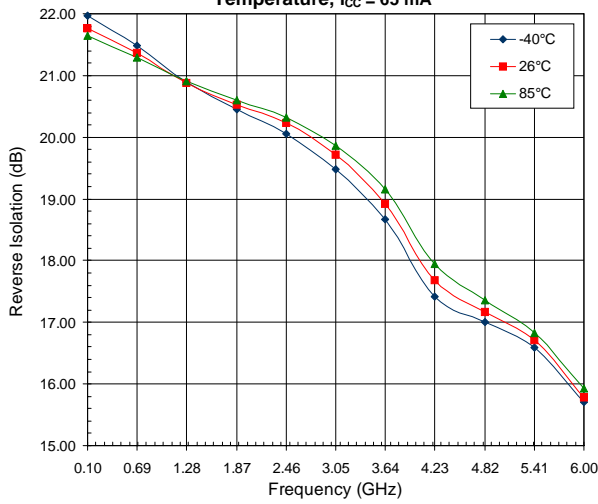


Output VSWR versus Frequency Across Temperature

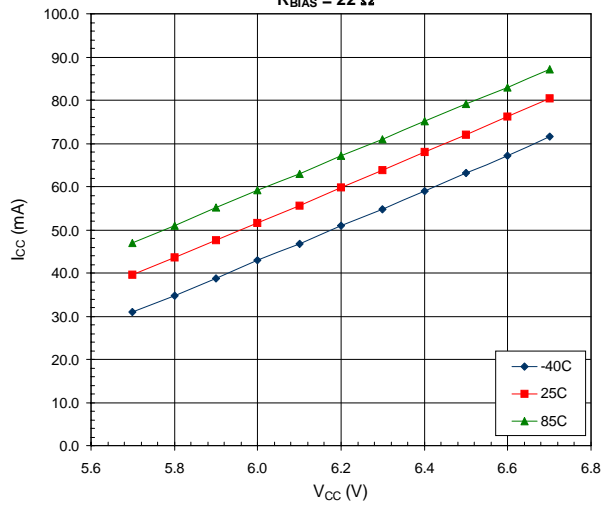


RF2334

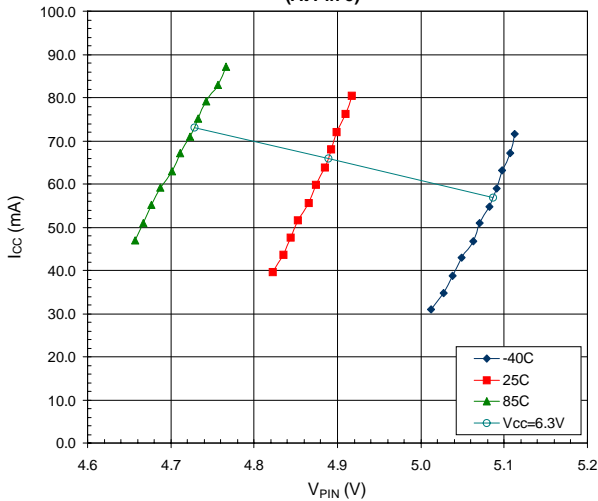
Reverse Isolation versus Frequency Across Temperature, $I_{CC} = 65 \text{ mA}$



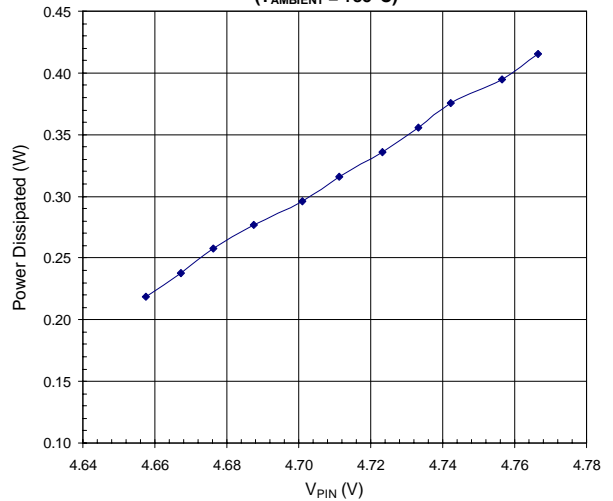
Current versus Voltage at Evaluation Board Connector, $R_{BIAS} = 22 \Omega$



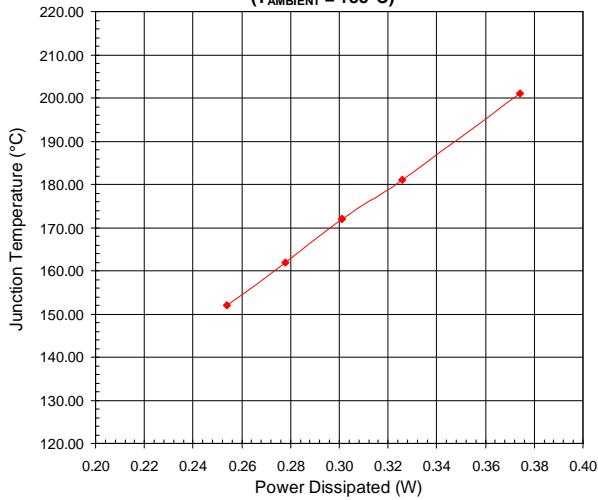
Current versus Voltage (At Pin 5)



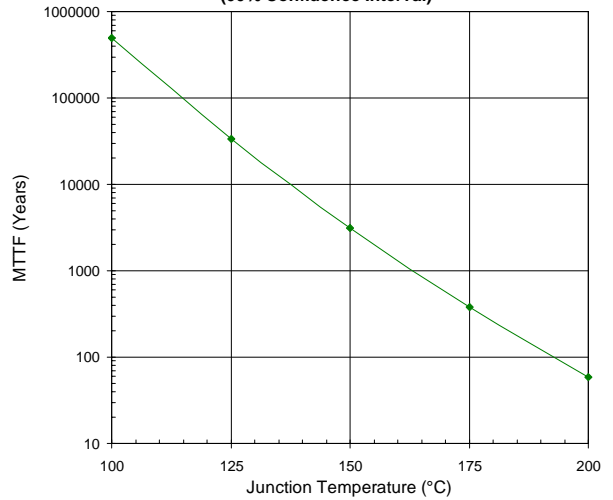
Power Dissipated versus Voltage at Pin 5 ($T_{AMBIENT} = +85^\circ\text{C}$)



Junction Temperature versus Power Dissipated ($T_{AMBIENT} = +85^\circ\text{C}$)

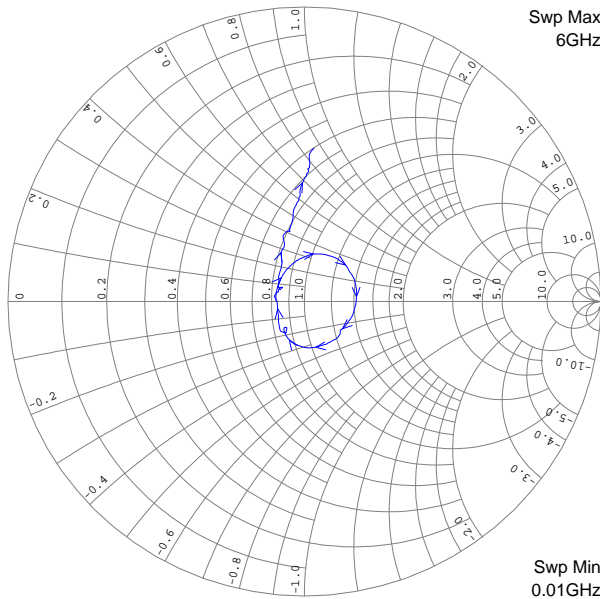


MTTF versus Junction Temperature (60% Confidence Interval)



De-Embedded S11, $V_{CC} = 4.84V$, $I_{CC} = 65mA$, $T = 25^{\circ}C$

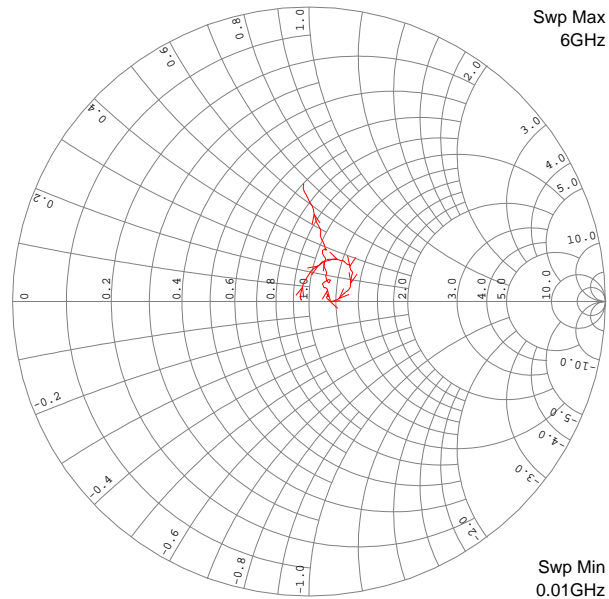
Swp Max
6GHz



Swp Min
0.01GHz

De-Embedded S22, $V_{CC} = 4.84V$, $I_{CC} = 65mA$, $T = 25^{\circ}C$

Swp Max
6GHz



Swp Min
0.01GHz

RF2334